

Photo DMOS-FET Relay

Description

The **LTU720** is a 1-From A and 1-Form B solid state relay in a 8 pin SMD package that employs optically coupled MOSFET technology to provide 3750V of input to output isolation. The optically coupled input is controlled by a highly efficient GaAlAs infrared LED and MOS FETs on the output side.

Features

- Low driver power requirements (TTL/CMOS Compatible)
- No moving parts
- High reliability
- Arc-Free with no snubbing circuits
- 3750Vrms Input/Output isolation

Applications

- Telecommunications (PC, Electronic notepad)
- Measuring and Testing equipment
- Industrial control
- Security equipments
- High speed inspection machine

Outline Dimensions

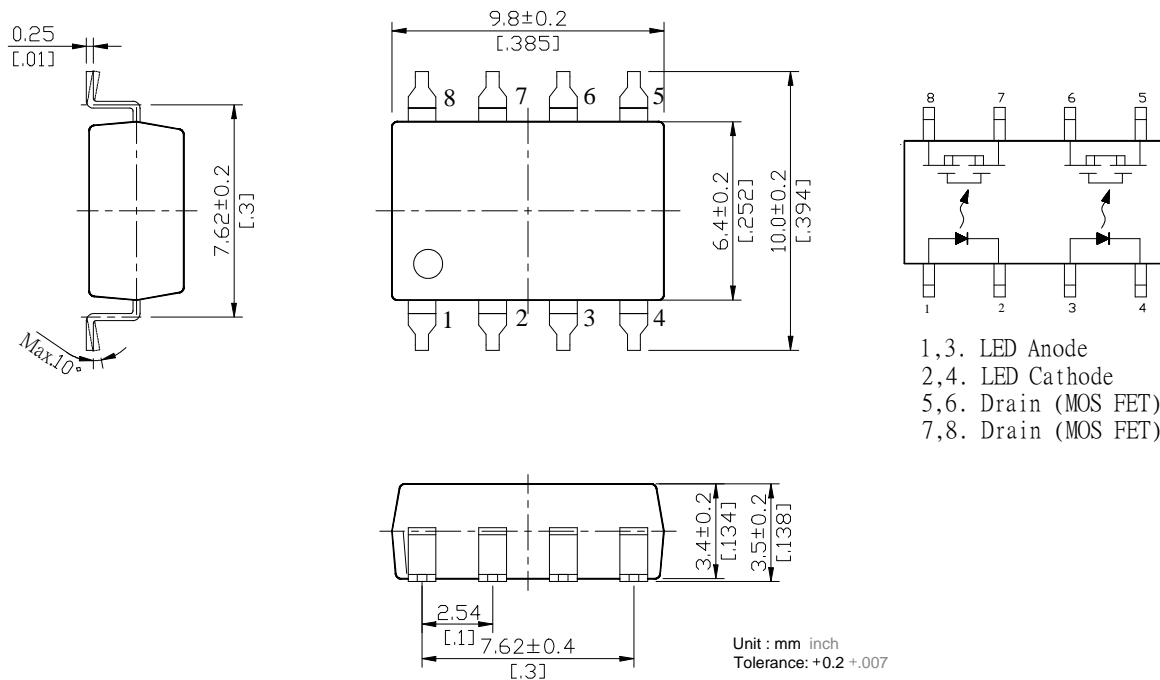


Photo DMOS-FET Relay Specifications

Part Name: LTU720

Absolute Maximum Ratings (Ambient Temperature: 25°C)

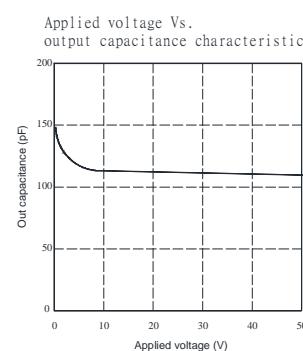
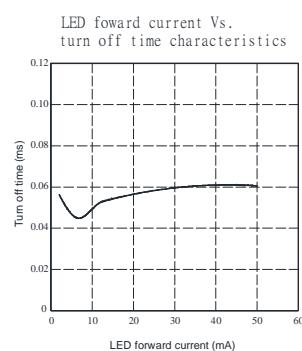
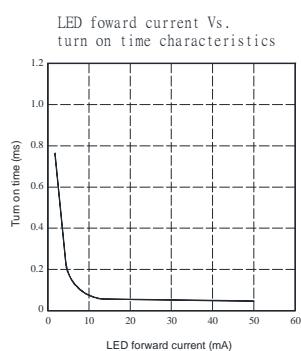
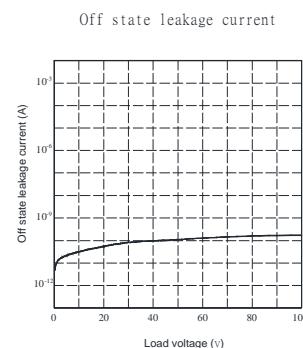
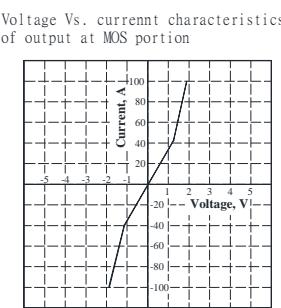
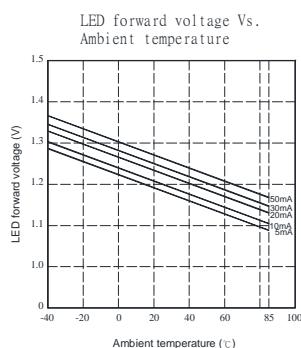
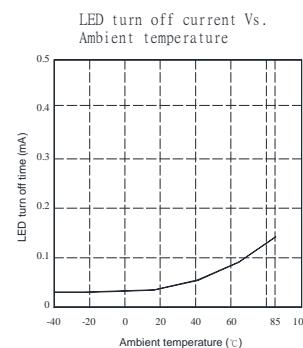
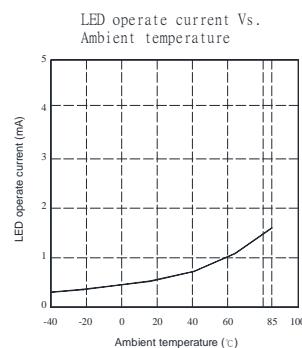
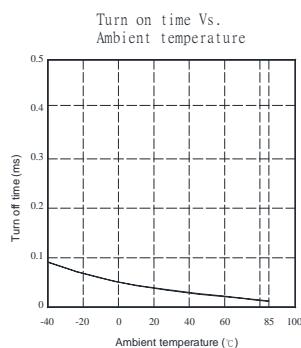
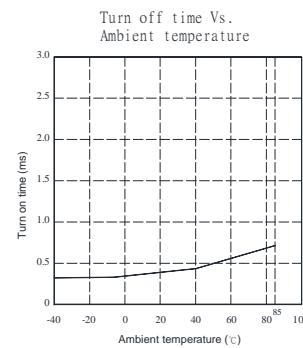
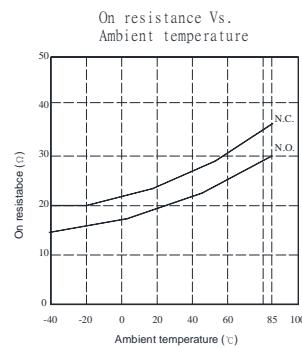
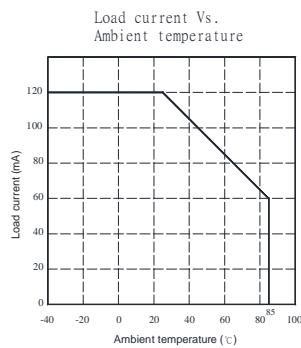
Item	Symbol	Value	Units	Note
Input	Continuous LED Current	IF	50	mA
	Peak LED Current	IFP	1000	mA
	LED Reverse Voltage	VR	5	V
	Input Power Dissipation	PIn	75	mW
Output	Load Voltage	VL	400	V(AC peak or DC)
	Load Current	IL	120	mA
	Peak Load Current	IPeak	0.6	A
	Output Power Dissipation	Pout	450	mW
Total Power Dissipation	PT	500	mW	
I/O Breakdown Voltage	VI/O	3750	Vrms	RH=60%, 1min
Operating Temperature	TOper	-40 to +85	-40 to +85	
Storage Temperature	TStg	-40 to +100	-40 to +100	
Pin Soldering Temperature	TSol	260	260	10 sec max.

Electrical Specifications (Ambient Temperature: 25°C)

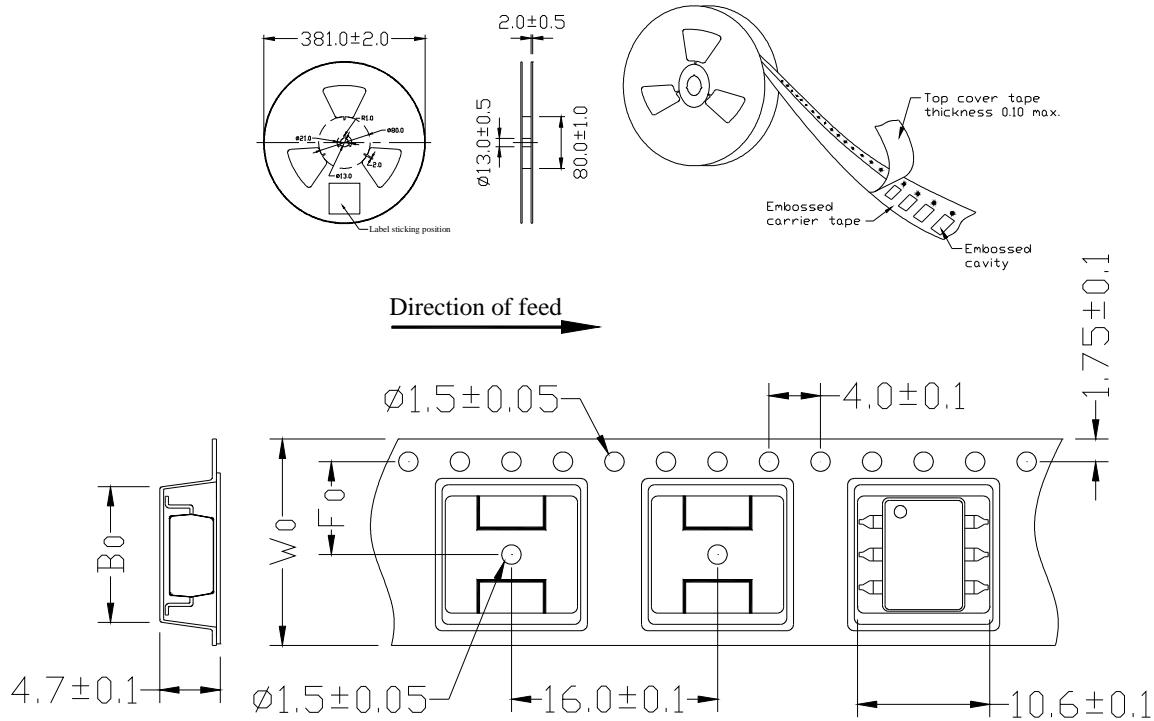
Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions		
Input	LED Forward Voltage	V _F		1.2	1.5	V		
	Operation LED Current	I _{F On}		0.5	5.0	mA		
	Recovery LED Current	I _{F Off}		0.35	0.5	mA		
	Recovery LED Voltage	V _{F Off}	0.5			V		
Output	On-Resistance	R _{on}		20(N.O.)	30(N.O.)	$I_F=5\text{mA}$ (N.O.) $I_F=0\text{mA}$ (N.C) $I_L=100\text{mA}$ Time to flow is within 1 sec.		
				20(N.C.)	50(N.C.)			
	Off-State Leakage Current	I _{Leak}		1(N.O.)	uA	$I_F=0\text{mA}$ (N.O.) $I_F=5\text{mA}$ (N.C) $V_L=$ Rating		
	Output Capacitance	C _{Out}		150		$I_F=5\text{mA}, V_L=0,$ $f=1\text{MHz}$		
Transmission	Turn-On Time	T _{On}		0.23(N.O.)	0.5(N.O.)	ms	$I_F=5\text{mA}, I_L=50\text{mA}$	
				0.2(N.C.)	1.0(N.C.)			
	Turn-Off Time	T _{off}		0.03(N.O.)	0.2(N.O.)	ms		
				0.5(N.C.)	3.0(N.C.)			
Coupled	I/O Isolation Resistance	R _{I/O}	10^{10}		Ω	DC500V		
	I/O Capacitance	C _{I/O}		0.8	pF	$f=1\text{MHz}$		



Reference Data

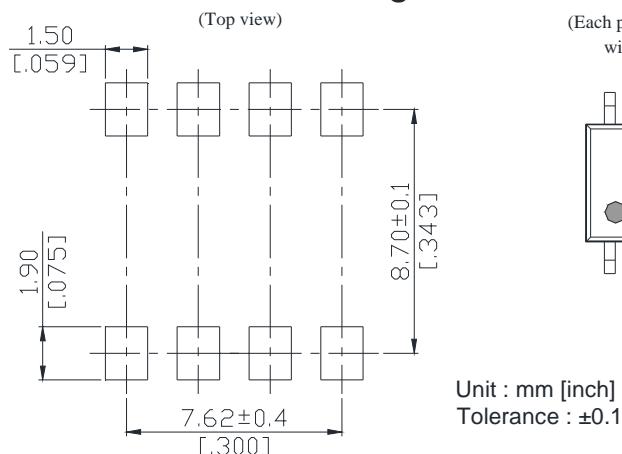


Taping Specifications for Surface Mount Devices



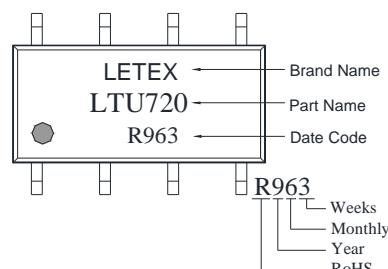
TYPE	$B_0 \pm 0.1$	$F_0 \pm 0.1$	$W_0 \pm 0.1$	13" REEL/PCS
4P	5.3	7.5	16	1000
6P	9.4	7.5	16	1000
8P	10.3	11.5	24	1000

Recommended Mounting Pad



Marking

(Each photo MOS Relay shall be marked with the following information)



- Note:
1. There shall be leader of 230 mm minimum which may consist of carrier and or cover tape follower by a minimum of 160 mm of carrier tape sealed with cover tape.
 2. There shall be a minimum of 160 mm of empty component pockets sealed with cover tape.
 3. Devices are pockets in accordance with EIA standard EIA-481-A and specifications given above.

